



## Selection Guide

Part No.	Dice	Lens Type	Iv (ucd) [1] @ 10mA		Description
			Min.	Typ.	
PSC23-11GWA	GREEN (GaP)	White Diffused	5600	14000	Common Cathode, Rt. Hand Decimal.
			*1400	*3700	

Note:

1. Luminous Intensity/ Luminous Flux: +/-15%.

\* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
$\lambda$ peak	Peak Wavelength	Green	565		nm	IF=20mA
$\lambda$ D[1]	Dominant Wavelength	Green	568		nm	IF=20mA
$\Delta\lambda$ 1/2	Spectral Line Half-width	Green	30		nm	IF=20mA
C	Capacitance	Green	15		pF	VF=0V;f=1MHz
VF[2]	Forward Voltage	A1,A2,D1,D2,P,K	4.4	5.0	V	IF=20mA
		B,C,E,F,G,H,J,L,M,N				
		DP	2.2	2.5		
IR	Reverse Current (Per chip)	A1,A2,D1,D2,P,K	Green	10 20 10	uA	VR = 5V VR = 5V VR = 5V
		B,C,E,F,G,H,J,L,M,N				
		DP				

Notes:

1. Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

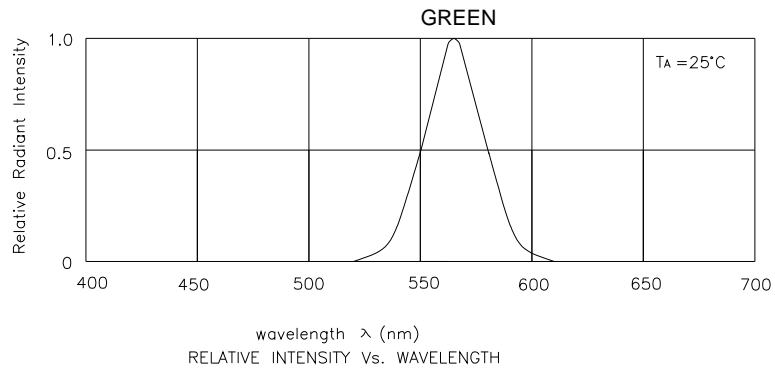
## Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units
Power dissipation	A1,A2,D1,D2,P,K	mW
	B,C,E,F,G,H,J,L,M,N	
	DP	
DC Forward Current	A1,A2,D1,D2,P,K	mA
	B,C,E,F,G,H,J,L,M,N	
	DP	
Peak Forward Current [1]	A1,A2,D1,D2,P,K	mA
	B,C,E,F,G,H,J,L,M,N	
	DP	
Reverse Voltage (Per chip)	A1,A2,D1,D2,P,K	V
	B,C,E,F,G,H,J,L,M,N	
	DP	
Operating / Storage Temperature	-40°C To +85°C	
Lead Solder Temperature [2]	260°C For 3-5 Seconds	

Notes:

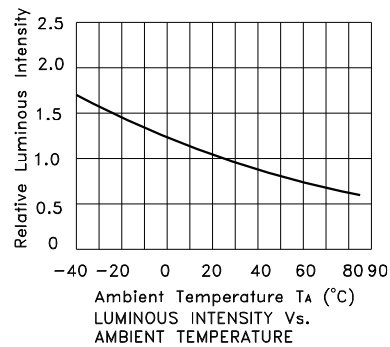
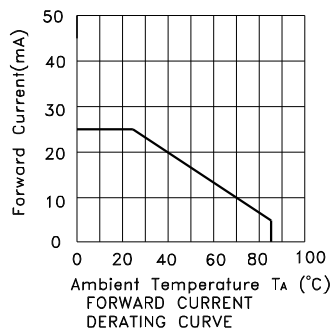
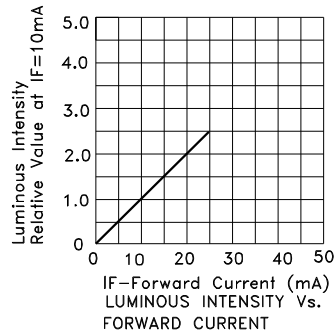
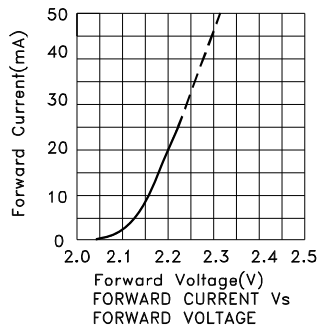
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. 2mm below package base.

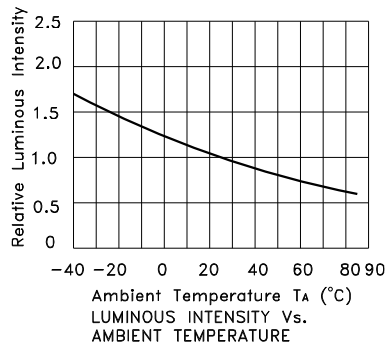
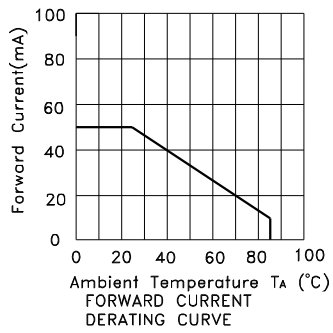
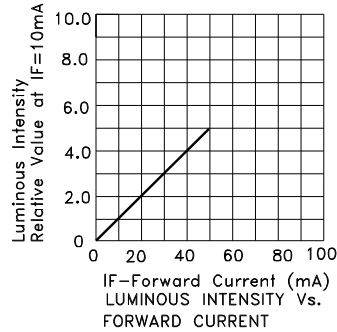
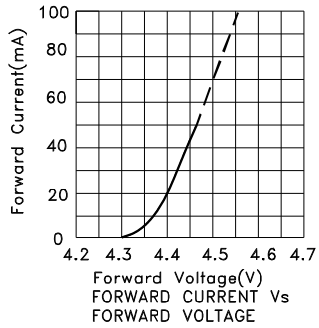


**Green**

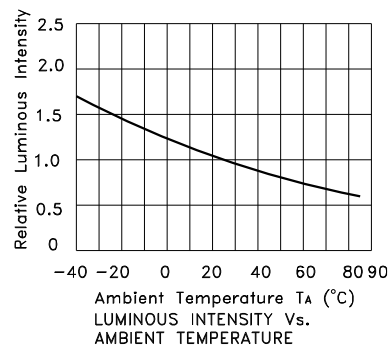
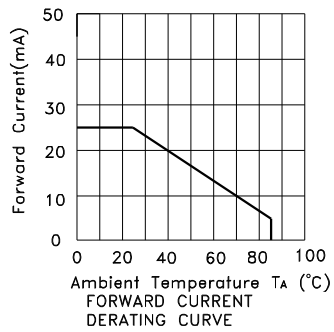
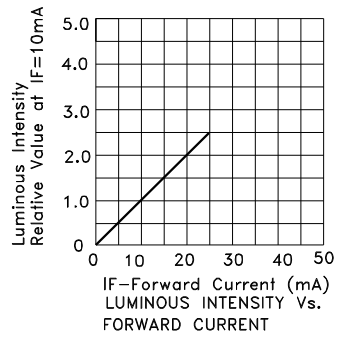
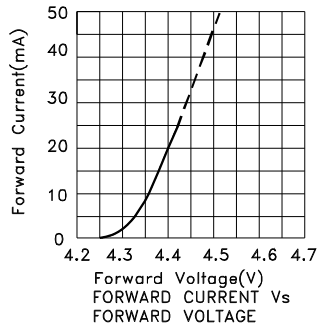
**PSC23-11GWA**



Note:the curves are on the DP.



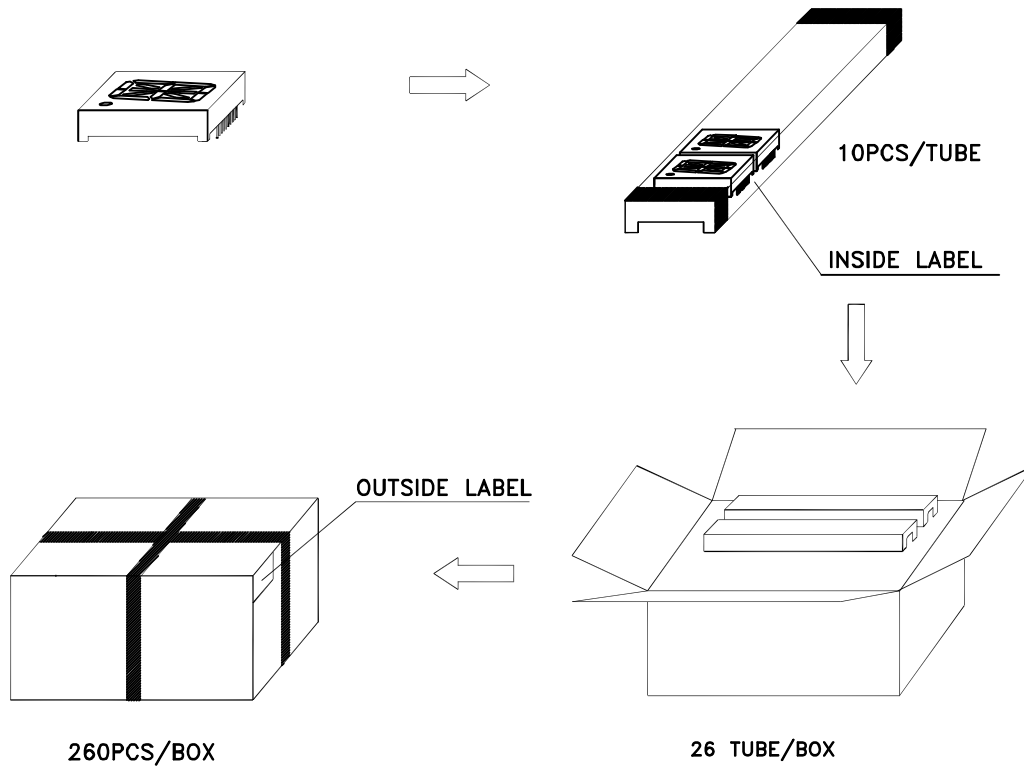
Note:the curves are on the segment b,c,e,f,g,h,j,l,m,n.



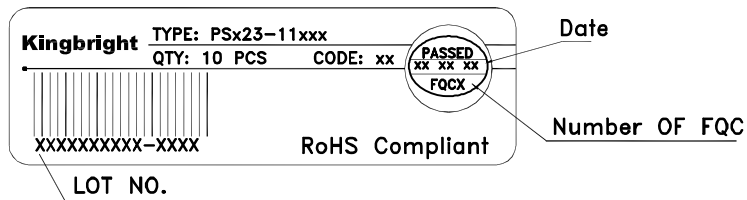
Note:the curves are on the segment a1,a2,d1,d2,p,k.

## PACKING & LABEL SPECIFICATIONS

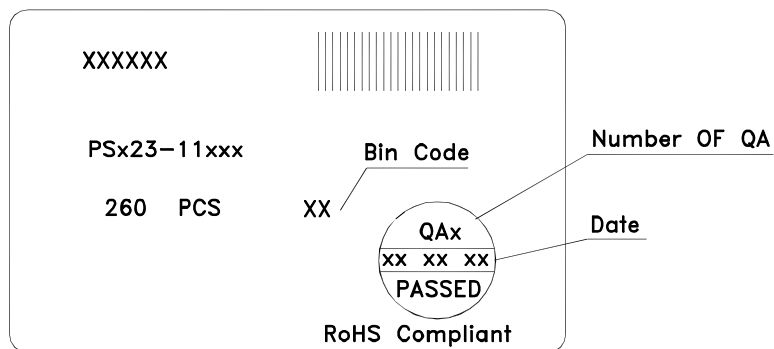
## PSC23-11GWA



### Inside Label On IC-tube



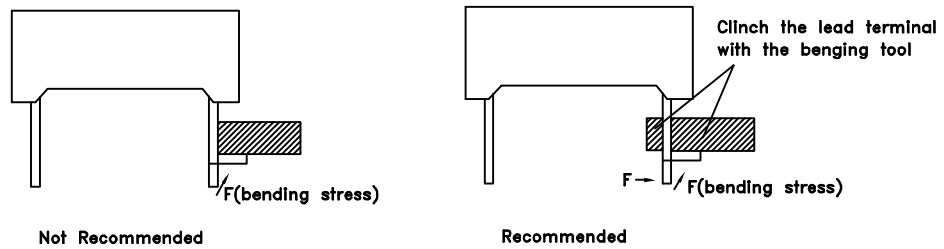
### Outside Label On Box



## THROUGH HOLE DISPLAY MOUNTING METHOD

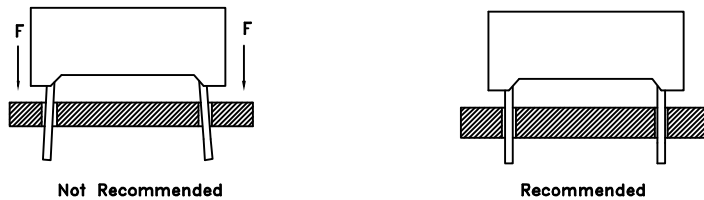
### Lead Forming

Do not bend the component leads by hand without proper tools.  
The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.

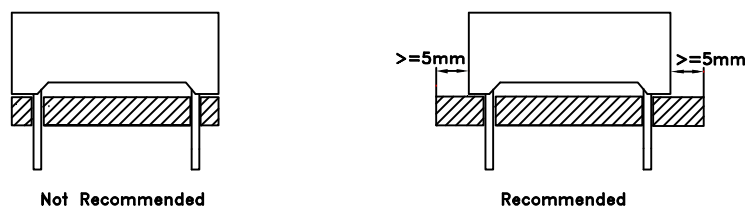


### Installation

- 1.The installation process should not apply stress to the lead terminals.
- 2.When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.

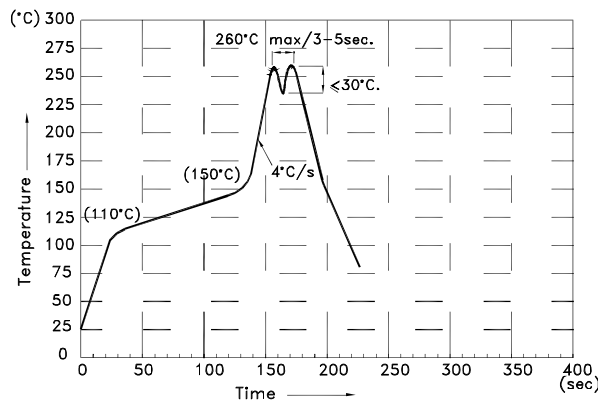


- 3.The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering.



## DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.



### NOTES:

1. Recommend the wave temperature 245°C~260°C. The maximum soldering temperature should be less than 260°C.
2. Do not apply stress on epoxy resins when temperature is over 85°C.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. During wave soldering, the PCB top-surface temperature should be kept below 105°C
5. No more than once.

### Soldering General Notes:

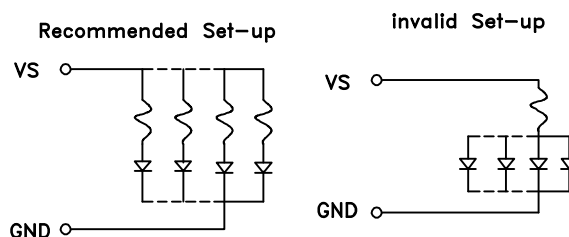
1. Through-hole displays are incompatible with reflow soldering.
2. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

### CLEANING

1. Mild "no-clean" fluxes are recommended for use in soldering.
2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts. And the devices should not be washed for more than one minute.

### CIRCUIT DESIGN NOTES

1. Protective current-limiting resistors may be necessary to operate the Displays.
2. LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.



All design applications should refer to Kingbright application notes available at <http://www.KingbrightUSA.com/ApplicationNotes>